

**Amendments to the Specification**

Please amend the specification at page 7, lines 9-13 as follows.

al The terminal pads 11, one of which is connected to the electrode 7 and extends as far as the edge of the substrate 2-6, and the other is provided on the dielectric film 8 and is electrically connected to the silicon structure 5, are provided on the substrate 6. These terminal pads 11 can be formed by using the same metal as the electrode 7 and the same method for forming thin-film.